

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TARIK J DICKENS	10/21/2020
MADHUPARNA ROY	10/19/2020
PHONG TRAN HOANG	10/19/2020
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Property Type	Number
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SIGNATURE:	/Alton Hornsby III/
DATE SIGNED:	12/27/2021
Total Attachments: 2	
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ASSIGNMENT OF INVENTION
TO
FLORIDA A&M UNIVERSITY, OFFICE OF TECHNOLOGY TRANSFER

WHEREAS, **Tarik J. Dickens** of Tallahassee Florida, USA, **Madhuparna Roy** of Tallahassee, Florida, USA, and **Phong Tran Hoang** of Tallahassee, Florida, USA (hereinafter “said inventors”), have made an invention entitled “**TESTBED PLATFORM FOR CHARACTERIZATION OF MATERIALS AND INKS USED IN ADDITIVE MANUFACTURING OF NANOCOMPOSITES**”, for which a provisional application for a patent of the United States was filed on October 2, 2020 and was given Application No. 63/086,619.

WHEREAS, **Florida A&M University, Office of Technology Transfer** a corporation or other business entity duly registered in the State/Country of Tallahassee, USA, whose postal address is 416 Foote-Hilyer Administration Center, Tallahassee, Florida 32307, or its affiliates (“ASSIGNEE”), desires to acquire the entire right, title, and interest in and to the invention, the application, and any patents to be granted for the invention in the United States in all foreign countries.

NOW THEREFORE, it is agreed that, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, said inventor has sold, assigned and transferred and by these present do sell, assign and transfer unto **Florida A&M University, Office of Technology Transfer** the entire right, title and interest in said invention in the United States of America and all foreign countries and in and to said U.S. non provisional patent application and all patent applications, divisions, substitutions, continuations and continuations-in-part thereof, and in all United States Letters Patents which may be granted thereon and all reissues and extensions thereof, and in all priority rights under the International Convention for the Protection of Industrial Property for every member country, and in all applications for patents (including related rights such as utility-model registrations, inventor’s certificates, and the like) heretofore or hereafter filed for said invention in any foreign countries, and in all patents (including all extensions, renewals and reissues thereof) granted for said invention; said applications and patents to be held and enjoyed by the said **Florida A&M University, Office of Technology Transfer** for its own use and for the use of its successors and assigns, to the full end of the term for which Letters Patent on same may be granted, as fully and entirely as the same would have been held by said inventors had this assignment and sale not been made.

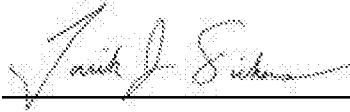
FURTHER, said inventor hereby agrees to sign all lawful papers necessary or helpful in obtaining patents on said invention or in filing any divisional, continuation, substitution, or reissue patent application or re-examination proceedings on said invention whether in the United States of America or in any foreign country.

REF. NO. 010368.006PV1

ASSIGNMENT OF INVENTION
TO
FLORIDA A&M UNIVERSITY, OFFICE OF TECHNOLOGY TRANSFER

Signed:

Date:



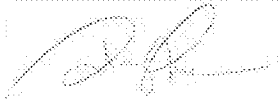
10/21/2020

Tarik J. Dickens



10/19/2020

Madhuparna Roy



10/19/2020

Phong Tran Hoang